CLAIM LISTING

Please find below a complete listing of presently pending claims with status identifiers. This listing of claims will replace all prior versions, and listings, of claims in the application.

1. (Currently Amended) A process for modifying the surface characteristics of a substrate comprising:

applying a polymer comprising multiple epoxy groups and having a number average molecular weight of about 2000 or greater to a substrate surface, wherein the substrate is formed of a substrate material that comprises functional groups that are reactive with epoxy;

reacting only a portion of the epoxy groups on the polymer with at least a portion of the functional groups of the substrate <u>material</u> to bind the polymer directly to the substrate material at multiple points along the polymer; and

cross-linking the polymer via reaction of only a portion of the epoxy groups on the polymer to form a cross-linked polymeric anchoring layer bound <u>directly</u> to the <u>substrate material at the</u> substrate surface, wherein the anchoring layer comprises epoxy functionality.

- 2. (Original) The process of claim 1, further comprising grafting at least one material to the anchoring layer at the epoxy functionality.
- 3. (Original) The process of claim 2, wherein the at least one material comprises a polymerization initiator.
- 4. (Original) The process of claim 3, further comprising polymerizing a monomer on the anchoring layer at the polymerization initiator.
- 5. (Original) The process of claim 4, wherein the monomer is capable of radical polymerization.
- 6. (Previously Presented) The process of claim 4, wherein the monomer is selected from the group consisting of a vinyl aromatic, an acrylate, and a methacrylate.
- 7. (Original) The process of claim 2, wherein the at least one material comprises a polymer, a macromolecule, or a biomolecule.

- 8. (Original) The process of claim 1, wherein the polymer is applied to the substrate surface in a dip-coating process.
- 9. (Original) The process of claim 1, wherein the polymer is applied to the substrate surface heterogeneously.
- 10. (Original) The process of claim 1, further comprising grafting two or more materials to the anchoring layer.
- 11. (Original) The process of claim 1, further comprising heating the substrate to a temperature of between about 40°C and 150°C following application of the polymer to the substrate surface.
- 12. (Previously Presented) The process of claim 1, wherein the substrate is heated subsequent to application of the polymer comprising multiple epoxy groups to the substrate surface.
- 13. (Original) The process of claim 1, further comprising oxidizing the substrate surface prior to application of the polymer to the substrate surface.
- 14. (Previously Presented) The process of claim 1, wherein the polymer is selected from the group consisting of epoxidized polybutadiene, epoxidized polyisoprene, and epoxidized poly(glycidyl methacrylate).
- 15. (Currently Amended) The process of claim 1, wherein the polymer is covalently bound to the surface substrate material at multiple points along the polymer.
- 16. (Currently Amended) The process of claim 1, wherein the substrate material is a textile material, a fiber, a polymeric material, or an inorganic material.
- 17. (Currently Amended) A process for modifying the surface characteristics of a substrate comprising:

applying a polymer comprising multiple epoxy groups and having a number average molecular weight of about 2000 or greater to a substrate surface, wherein the substrate <u>is formed of a substrate material that</u> comprises functional groups that are reactive with epoxy;

reacting between about 5% and about 40% of the epoxy groups on the polymer with at least a portion of the functional groups of the substrate <u>material</u> to bind

the epoxy-containing polymer directly to the substrate <u>material</u> at multiple points along the polymer;

reacting between about 20% and about 30% of the epoxy groups on the polymer to form cross-links such that a cross-linked polymeric anchoring layer is formed bound <u>directly</u> to the substrate <u>material</u>, wherein the anchoring layer comprises epoxy functionality; and

grafting at least one material to the anchoring layer at the epoxy functionality.

- 18. (Original) The process of claim 17, wherein the at least one material comprises a polymerization initiator.
- 19. (Original) The process of claim 18, further comprising polymerizing a monomer on the anchoring layer at the polymerization initiator via an atom transfer radical polymerization.
- 20. (Previously Presented) The process of claim 19, wherein the monomer is selected from the group consisting of a vinyl aromatic monomer, an acrylate, and a methacrylate.
- 21. (Original) The process of claim 17, wherein the at least one material comprises a polymer, a macromolecule, or a biomolecule.
- 22. (Original) The process of claim 17, wherein the epoxy-containing polymer is applied to the substrate surface in a dip-coating process.
- 23. (Original) The process of claim 17, wherein the epoxy-containing polymer is applied to the substrate surface heterogeneously.
- 24. (Original) The process of claim 17, further comprising grafting two or more materials to the anchoring layer.
- 25. (Original) The process of claim 17, further comprising oxidizing the substrate surface prior to application of the epoxy-containing polymer to the substrate surface.
- 26. (Previously Presented) The process of claim 17, wherein the epoxy-containing polymer is selected from the group consisting of epoxidized polybutadiene, epoxidized polyisoprene, and epoxidized poly(glycidyl methacrylate).

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27. (Previously Presented) The process of claim 17, wherein the epoxycontaining polymer is poly(glycidyl methacrylate) comprising epoxy functionality. 28-48. Cancelled.